

### **General Description**

The SJS3407B uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as -2.5V. This device is suitable for use as a wide variety of applications.

#### Features

- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

#### Application

- PWM Applications
- Load Switch
- Power Management

#### **Key Performance Parametes**

Parameter	Value	Unit
V <sub>DS</sub>	-30	V
R <sub>DS(ON)_TYP</sub>	32.3	mΩ
lo	-4.7	А
Q <sub>G</sub>	9	nC



**Schematic Diagram** 

SOT-23 top view

#### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJS3407	3407B	SOT-23	Таре	١	١	3000 Pcs

## Table 1. Absolute Maximum Ratings (T<sub>A</sub>=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V <sub>DS</sub>	Drain-Source Voltage (V <sub>GS</sub> =0V)	-30	V
V <sub>GS</sub>	Gate-Source Voltage (V <sub>DS</sub> =0V)	±20	V
1	Drain Current-Continuous(T <sub>A</sub> =25℃)		А
lD	Drain Current-Continuous(T <sub>A</sub> =100°C)	-3	А
DM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-18.8	А
P	Maximum Power Dissipation(T <sub>A</sub> =25°C)	1.5	W
PD	Maximum Power Dissipation(T <sub>A</sub> =100°C)	0.6	W
E <sub>AS</sub>	Avalanche energy (Note 2)	25	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

## Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient		81	°C/W



## Table 3. Electrical Characteristics (T\_J=25 $^{\circ}$ C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	-30			V
		V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V TJ=25℃			1	μA
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃			100	μA
lgss	Gate-Body Leakage Current	$V_{GS}=\pm 10V, V_{DS}=0V$			±10	μA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	-1		-2.5	V
<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> =-5V, I <sub>D</sub> =-2A		4.7		S
Rds(on)	Drain-Source On-State Resistance	V <sub>GS</sub> =-10V, I <sub>D</sub> =-2A T <sub>J</sub> =25℃		32.3	42	mΩ
Rds(on)	Drain-Source On-State Resistance	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1.5A T <sub>J</sub> =25℃		43.3	57.6	mΩ
Dynamic Chara	icteristics					
Ciss	Input Capacitance			616		pF
Coss	Output Capacitance	V <sub>DS</sub> =-15V,V <sub>GS</sub> =0V, f=1.0MHz		76		pF
Crss	Reverse Transfer Capacitance			64		pF
Rg	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		6.4		Ω
Switching Para	meters	·				
t <sub>d(on)</sub>	Turn-on Delay Time			8		nS
tr	Turn-on Rise Time	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V,		16		nS
$t_{d(off)}$	Turn-Off Delay Time	R <sub>L</sub> =7.5Ω, R <sub>GEN</sub> =3Ω		45		nS
t <sub>f</sub>	Turn-Off Fall Time			34		nS
Qg	Total Gate Charge			9		nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, I <sub>D</sub> =-2A		2		nC
$Q_gd$	Gate-Drain Charge			2		nC
Source-Drain D	iode Characteristics	·				
I <sub>SD</sub>	Source-Drain Current (Body Diode)				-4.7	А
Vsd	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =-2A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	l⊧=-2A, dl/dt=100A/µs		8		ns
Qrr	Reverse Recovery Charge	I⊧=-2A, dl/dt=100A/μs		3		nC

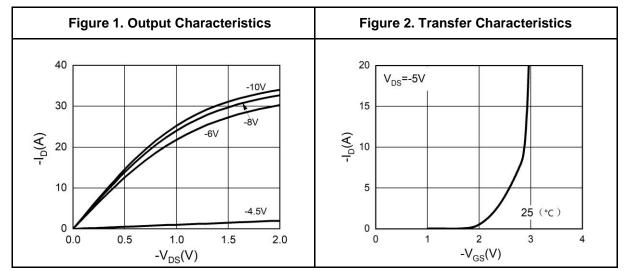
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

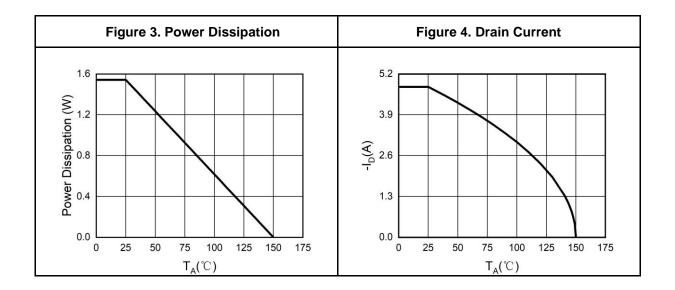
Notes 2.E<sub>AS</sub> condition:  $T_J=25^{\circ}C$ ,  $V_{DD}=-30V$ ,  $V_G=10V$ ,  $Rg=25\Omega$ , L=0.5mH.

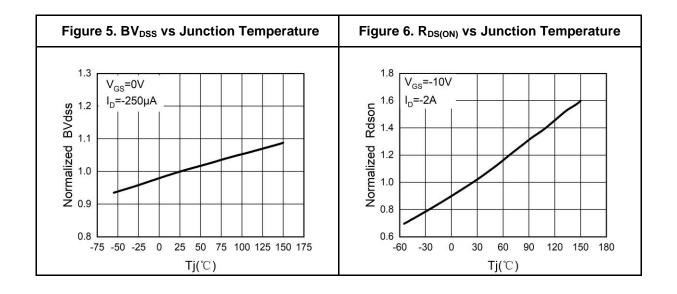
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## **Typical Electrical And Thermal Characteristics (Curves)**



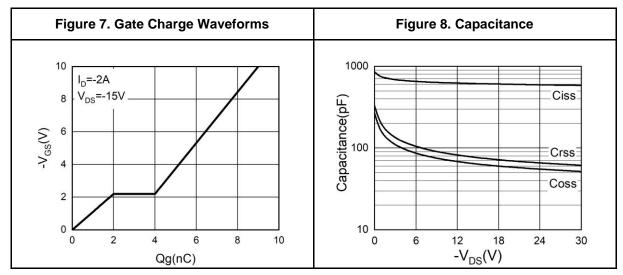


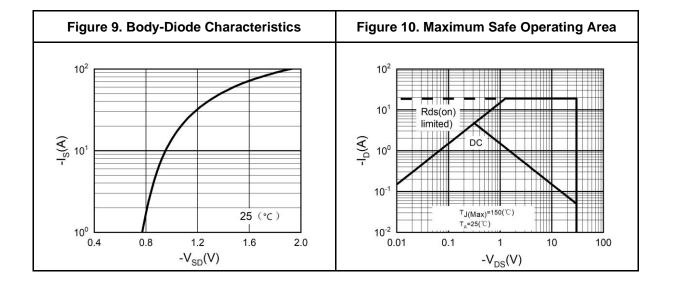




SJS3407B

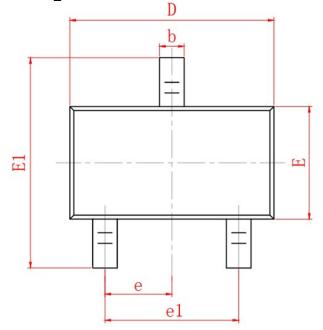
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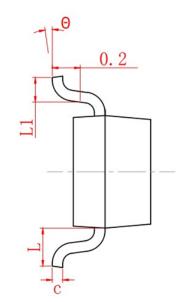


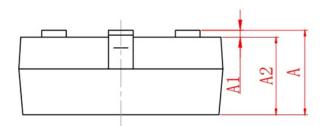




# SOT-23 Package Information







SYMBOL	MIN	NOM	MAX	
A	0.90	1.05	1.20	
A1	0.00	0.05	0.10	
A2	0.90	1.00	1.10	
b	0.30	0.40	0.50	
с	0.08	0.10	0.15	
D	2.80	2.90	3.00	
E	1.20	1.30	1.40	
E1	2.30	2.40	2.50	
L	0.30	0.40	0.50	
θ	0°	5° 10°		
L1	0.55 REF			
e	0.95 BSC			
e1	1.90 REF			



## Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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